

# Single-Channel: 6N138M, 6N139M Dual-Channel: HCPL2730M, HCPL2731M (Preliminary) Low Input Current High Gain Split Darlington Optocouplers

## Features

- Low current – 0.5mA
- Superior CTR-2000%
- Superior CMR-10kV/μs
- CTR guaranteed 0–70°C
- U.L. recognized (File # E90700, Vol. 2)
- VDE recognition (pending)
  - Ordering option V, e.g., 6N138VM
- Dual Channel – HCPL2730M, HCPL2731M (coming soon)

## Applications

- Digital logic ground isolation
- Telephone ring detector
- EIA-RS-232C line receiver
- High common mode noise line receiver
- μP bus isolation
- Current loop receiver

## Description

The 6N138M/9M and HCPL2730M/31M optocouplers consist of an AlGaAs LED optically coupled to a high gain split darlington photodetector.

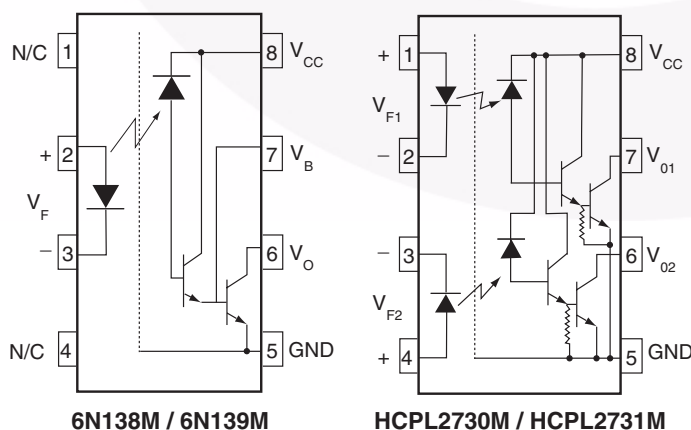
The split darlington configuration separating the input photodiode and the first stage gain from the output transistor permits lower output saturation voltage and higher speed operation than possible with conventional darlington phototransistor optocoupler. In the dual channel devices, HCPL2730M/HCPL2731M, an integrated emitter-base resistor provides superior stability over temperature.

The combination of a very low input current of 0.5mA and a high current transfer ratio of 2000% makes this family particularly useful for input interface to MOS, CMOS, LSTTL and EIA RS232C, while output compatibility is ensured to CMOS as well as high fan-out TTL requirements. An internal noise shield provides exceptional common mode rejection of 10 kV/μs.

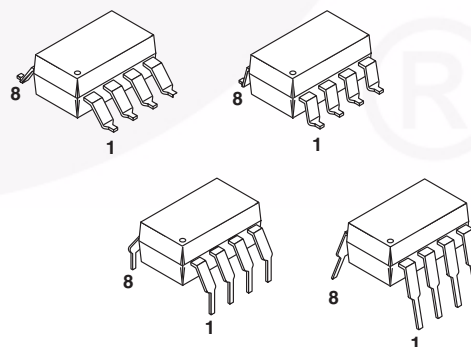
## Related Resources

- [www.fairchildsemi.com/products/opto/](http://www.fairchildsemi.com/products/opto/)
- [www.fairchildsemi.com/pf/Hc/HCPL0700.html](http://www.fairchildsemi.com/pf/Hc/HCPL0700.html)
- [www.fairchildsemi.com/pf/Hc/HCPL0730.html](http://www.fairchildsemi.com/pf/Hc/HCPL0730.html)
- [www.fairchildsemi.com/pf/Hc/HCPL0731.html](http://www.fairchildsemi.com/pf/Hc/HCPL0731.html)

## Schematic



## Package Outlines



**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$  unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol    | Parameter                                                                                                    | Value          | Units            |
|-----------|--------------------------------------------------------------------------------------------------------------|----------------|------------------|
| $T_{STG}$ | Storage Temperature                                                                                          | -40 to +125    | $^\circ\text{C}$ |
| $T_{OPR}$ | Operating Temperature                                                                                        | -40 to +100    | $^\circ\text{C}$ |
| $T_{SOL}$ | Lead Solder Temperature (Wave solder only. See recommended reflow profile graph on page 13 for SMD mounting) | 260 for 10 sec | $^\circ\text{C}$ |

**EMITTER**

|               |                                                                     |              |     |    |
|---------------|---------------------------------------------------------------------|--------------|-----|----|
| $I_F$ (avg)   | DC/Average Forward Input Current                                    | Each Channel | 20  | mA |
| $I_F$ (pk)    | Peak Forward Input Current<br>(50% duty cycle, 1 ms P.W.)           | Each Channel | 40  | mA |
| $I_F$ (trans) | Peak Transient Input Current – ( $\leq 1\mu\text{s}$ P.W., 300 pps) |              | 1.0 | A  |
| $V_R$         | Reverse Input Voltage                                               | Each Channel | 5   | V  |
| $P_D$         | Input Power Dissipation <sup>(1)</sup>                              | Each Channel | 35  | mW |

**DETECTOR**

|               |                                         |                      |            |    |
|---------------|-----------------------------------------|----------------------|------------|----|
| $I_O$ (avg)   | Average Output Current                  | Each Channel         | 60         | mA |
| $V_{ER}$      | Emitter-Base Reverse Voltage            | 6N138M and 6N139M    | 0.5        | V  |
| $V_{CC}, V_O$ | Supply Voltage, Output Voltage          | 6N138M and HCPL2730M | -0.5 to 7  | V  |
|               |                                         | 6N139M and HCPL2731M | -0.5 to 18 |    |
| $P_O$         | Output Power Dissipation <sup>(1)</sup> | Each Channel         | 100        | mW |

**Note:**

1. No derating required for devices operated within the  $T_{OPR}$  specification (6N138 and 6N139 only). HCPL2730 and HCPL2731 derating TBD.

## Electrical Characteristics

( $T_A = 0$  to  $70^\circ\text{C}$  unless otherwise specified. Typical value is measured at  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5.0\text{V}$ .)

### Individual Component Characteristics

| Symbol                    | Parameter                                  | Test Conditions                                                                                                                          | Device                                      | Min. | Typ.   | Max. | Unit                 |
|---------------------------|--------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------|------|--------|------|----------------------|
| <b>EMITTER</b>            |                                            |                                                                                                                                          |                                             |      |        |      |                      |
| $V_F$                     | Input Forward Voltage                      | $T_A = 25^\circ\text{C}$<br>Each channel ( $I_F = 1.6\text{mA}$ )                                                                        | All                                         |      | 1.30   | 1.7  | V                    |
| $BV_R$                    | Input Reverse Breakdown Voltage            | $T_A = 25^\circ\text{C}$ , $I_R = 10\mu\text{A}$                                                                                         | All                                         | 5.0  | 19     |      | V                    |
| $\Delta V_F / \Delta T_A$ | Temperature Coefficient of Forward Voltage | $I_F = 1.6\text{mA}$                                                                                                                     | All                                         |      | -1.94  |      | mV/ $^\circ\text{C}$ |
| <b>DETECTOR</b>           |                                            |                                                                                                                                          |                                             |      |        |      |                      |
| $I_{OH}$                  | Logic HIGH Output Current                  | $I_F = 0\text{mA}$ , $V_O = V_{CC} = 18\text{V}$<br>Each Channel                                                                         | 6N139M<br>HCPL2731M                         |      | 0.0036 | 100  | $\mu\text{A}$        |
|                           |                                            | $I_F = 0\text{mA}$ , $V_O = V_{CC} = 7\text{V}$<br>Each Channel                                                                          | 6N138M<br>HCPL2730M                         |      | 0.001  | 250  |                      |
| $I_{CCL}$                 | Logic LOW supply                           | $I_F = 1.6\text{mA}$ , $V_O = \text{Open}$ , $V_{CC} = 18\text{V}$<br>$I_{F1} = I_{F2} = 1.6\text{mA}$ , $V_{O1} = V_{O2} = \text{Open}$ | 6N138M,<br>6N139M<br>HCPL2731M<br>HCPL2730M |      | 0.4    | 1.5  | mA                   |
|                           |                                            | $V_{CC} = 18\text{V}$<br>$V_{CC} = 7\text{V}$                                                                                            | HCPL2731M<br>HCPL2730M                      |      |        | 3    |                      |
| $I_{CCH}$                 | Logic HIGH Supply                          | $I_F = 0\text{mA}$ , $V_O = \text{Open}$ , $V_{CC} = 18\text{V}$<br>$I_{F1} = I_{F2} = 0\text{mA}$ , $V_{O1} = V_{O2} = \text{Open}$     | 6N138M,<br>6N139M<br>HCPL2731M<br>HCPL2730M |      | 0.0003 | 10   | $\mu\text{A}$        |
|                           |                                            | $V_{CC} = 18\text{V}$<br>$V_{CC} = 7\text{V}$                                                                                            | HCPL2731M<br>HCPL2730M                      |      |        | 20   |                      |

### Transfer Characteristics

| Symbol         | Parameter                                | Test Conditions                                                                                                                                          | Device                        | Min. | Typ.          | Max. | Unit |
|----------------|------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|------|---------------|------|------|
| <b>COUPLED</b> |                                          |                                                                                                                                                          |                               |      |               |      |      |
| CTR            | Current Transfer Ratio <sup>(2)(3)</sup> | $I_F = 0.5\text{mA}$ , $V_O = 0.4\text{V}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel                                                                      | 6N139M<br>HCPL2731M           | 400  | 2000          |      | %    |
|                |                                          | $I_F = 1.6\text{mA}$ , $V_O = 0.4\text{V}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel                                                                      | 6N139M<br>HCPL2731M           | 500  | 1600          |      |      |
|                |                                          | $I_F = 1.6\text{mA}$ , $V_O = 0.4\text{V}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel                                                                      | 6N138M<br>HCPL2730M           | 300  | 1600          |      |      |
| $V_{OL}$       | Logic LOW Output Voltage <sup>(3)</sup>  | $I_F = 0.5\text{mA}$ , $I_O = 2\text{mA}$ , $V_{CC} = 4.5\text{V}$<br>$I_F = 1.6\text{mA}$ , $I_O = 8\text{mA}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel | 6N139M<br>6N139M<br>HCPL2731M |      | 0.05<br>0.093 | 0.4  | V    |
|                |                                          | $I_F = 5\text{mA}$ , $I_O = 15\text{mA}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel                                                                        | 6N139M<br>HCPL2731M           |      | 0.13          | 0.4  |      |
|                |                                          | $I_F = 12\text{mA}$ , $I_O = 24\text{mA}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel                                                                       | 6N139M<br>HCPL2731M           |      | 0.18          | 0.4  |      |
|                |                                          | $I_F = 1.6\text{mA}$ , $I_O = 4.8\text{mA}$ , $V_{CC} = 4.5\text{V}$<br>Each Channel                                                                     | 6N138M<br>HCPL2730M           |      | 0.06          | 0.4  |      |

# Electrical Characteristics (Continued)

( $T_A = 0$  to  $70^\circ\text{C}$  unless otherwise specified. Typical value is measured at  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5.0\text{V}$ .)

## Switching Characteristics ( $V_{CC} = 5\text{V}$ )

| Symbol     | Parameter                                                                      | Test Conditions                                                                                                              | Device                                     | Min.  | Typ.   | Max.     | Unit                   |
|------------|--------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------|-------|--------|----------|------------------------|
| $t_{PHL}$  | Propagation Delay<br>Time to Logic<br>LOW <sup>(3)</sup> (Fig. 12)             | $R_L = 4.7\text{k}\Omega$ , $I_F = 0.5\text{mA}$<br>$T_A = 25^\circ\text{C}$                                                 | 6N139M                                     |       | 2.5    | 30       | $\mu\text{s}$          |
|            |                                                                                | $R_L = 4.7\text{k}\Omega$ , $I_F = 0.5\text{mA}$<br>Each Channel<br>$T_A = 25^\circ\text{C}$                                 | HCPL2731M                                  |       |        | 120      |                        |
|            |                                                                                | $R_L = 270\Omega$ , $I_F = 12\text{mA}$<br>$T_A = 25^\circ\text{C}$                                                          | 6N139M                                     |       | 0.24   | 2        |                        |
|            |                                                                                | $R_L = 270\Omega$ , $I_F = 12\text{mA}$ , Each Channel<br>$T_A = 25^\circ\text{C}$                                           | HCPL2730M<br>HCPL2731M                     |       |        | 3<br>2   |                        |
|            |                                                                                | $R_L = 2.2\text{k}\Omega$ , $I_F = 1.6\text{mA}$<br>$T_A = 25^\circ\text{C}$                                                 | 6N138M                                     |       | 1      | 15<br>10 |                        |
|            |                                                                                | $R_L = 2.2\text{k}\Omega$ , $I_F = 1.6\text{mA}$ , Each Channel<br>$T_A = 25^\circ\text{C}$                                  | HCPL2731M<br>HCPL2730M                     |       |        | 25<br>20 |                        |
|            |                                                                                |                                                                                                                              |                                            |       |        |          |                        |
|            |                                                                                |                                                                                                                              |                                            |       |        |          |                        |
| $t_{PLH}$  | Propagation Delay<br>Time to Logic<br>HIGH <sup>(3)</sup> (Fig. 12)            | $R_L = 4.7\text{k}\Omega$ , $I_F = 0.5\text{mA}$<br>Each Channel                                                             | 6N139M<br>HCPL2731M                        |       |        | 90       | $\mu\text{s}$          |
|            |                                                                                | $R_L = 4.7\text{k}\Omega$ , $I_F = 0.5\text{mA}$ , $T_A = 25^\circ\text{C}$<br>Each Channel                                  | 6N139M<br>HCPL2731M                        |       | 13.6   | 60       |                        |
|            |                                                                                | $R_L = 270\Omega$ , $I_F = 12\text{mA}$<br>$T_A = 25^\circ\text{C}$                                                          | 6N139M                                     |       | 1.3    | 10<br>7  |                        |
|            |                                                                                | $R_L = 270\Omega$ , $I_F = 12\text{mA}$ , Each Channel<br>$T_A = 25^\circ\text{C}$                                           | HCPL2730M<br>HCPL2731M                     |       |        | 15<br>10 |                        |
|            |                                                                                | $R_L = 2.2\text{k}\Omega$ , $I_F = 1.6\text{mA}$<br>Each Channel                                                             | 6N138M<br>HCPL2730M<br>HCPL2731M           |       |        | 50       |                        |
|            |                                                                                | $R_L = 2.2\text{k}\Omega$ , $I_F = 1.6\text{mA}$ , $T_A = 25^\circ\text{C}$<br>Each Channel                                  | 6N138M<br>HCPL2730M<br>HCPL2731M           |       | 7.3    | 35       |                        |
|            |                                                                                |                                                                                                                              |                                            |       |        |          |                        |
|            |                                                                                |                                                                                                                              |                                            |       |        |          |                        |
| $ICM_{HI}$ | Common Mode<br>Transient<br>Immunity at Logic<br>HIGH <sup>(4)</sup> (Fig. 13) | $I_F = 0\text{mA}$ , $ V_{CM}  = 10\text{V}_{P-P}$ , $T_A = 25^\circ\text{C}$ ,<br>$R_L = 2.2\text{k}\Omega$<br>Each Channel | 6N138M<br>6N139M<br>HCPL2730M<br>HCPL2731M | 1,000 | 10,000 |          | $\text{V}/\mu\text{s}$ |
| $ICM_{LI}$ | Common Mode<br>Transient<br>Immunity at Logic<br>LOW <sup>(4)</sup> (Fig. 13)  | $(I_F = 1.6\text{mA},  V_{CM}  = 10\text{V}_{P-P}, R_L = 2.2\text{k}\Omega)$<br>$T_A = 25^\circ\text{C}$<br>Each Channel     | 6N138M<br>6N139M<br>HCPL2730M<br>HCPL2731M | 1,000 | 10,000 |          | $\text{V}/\mu\text{s}$ |

**Electrical Characteristics** (Continued)(T<sub>A</sub> = 0 to 70°C unless otherwise specified. Typical value is measured at T<sub>A</sub> = 25°C and V<sub>CC</sub> = 5.0V.)**Isolation Characteristics**

| Symbol           | Characteristics                                       | Test Conditions                                                            | Min. | Typ.             | Max. | Unit             |
|------------------|-------------------------------------------------------|----------------------------------------------------------------------------|------|------------------|------|------------------|
| V <sub>ISO</sub> | Withstand Insulation Test Voltage <sup>(5)</sup>      | RH ≤ 50%, T <sub>A</sub> = 25°C, I <sub>I-O</sub> ≤ 10μA, 50Hz, t = 1 min. | 5000 |                  |      | V <sub>RMS</sub> |
| R <sub>I-O</sub> | Resistance (Input to Output) <sup>(5)</sup>           | V <sub>I-O</sub> = 500VDC                                                  |      | 10 <sup>11</sup> |      | Ω                |
| C <sub>I-O</sub> | Capacitance (Input to Output) <sup>(5)(6)</sup>       | f = 1MHz, V <sub>I-O</sub> = 500V                                          |      | 1                |      | pF               |
| I <sub>I-I</sub> | Input-Input Insulation Leakage Current <sup>(7)</sup> | RH ≤ 45%, V <sub>I-I</sub> = 500VDC, t = 5s, HCPL2730M/2731M only          |      | 0.005            |      | μA               |
| R <sub>I-I</sub> | Input-Input Resistance <sup>(7)</sup>                 | V <sub>I-I</sub> = 500VDC, HCPL2730M/2731M only                            |      | 10 <sup>11</sup> |      | Ω                |
| C <sub>I-I</sub> | Input-Input Capacitance <sup>(7)</sup>                | f = 1MHz, HCPL2730M/2731M only                                             |      | 0.03             |      | pF               |

**Notes:**

- Current Transfer Ratio is defined as a ratio of output collector current, I<sub>O</sub>, to the forward LED input current, I<sub>F</sub>, times 100%.
- Pin 7 open. (6N138M and 6N139M only)
- Common mode transient immunity in logic HIGH level is the maximum tolerable (positive) dV<sub>cm</sub>/dt on the leading edge of the common mode pulse signal V<sub>CM</sub>, to assure that the output will remain in a logic HIGH state (i.e., V<sub>O</sub> > 2.0V). Common mode transient immunity in logic LOW level is the maximum tolerable (negative) dV<sub>cm</sub>/dt on the trailing edge of the common mode pulse signal, V<sub>CM</sub>, to assure that the output will remain in a logic LOW state (i.e., V<sub>O</sub> < 0.8V).
- Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.
- For dual channel devices, C<sub>I-O</sub> is measured by shorting pins 1 and 2 or pins 3 and 4 together and pins 5 through 8 shorted together.
- Measured between pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

# Electrical Characteristics (Continued) $T_A = 25^\circ\text{C}$ unless otherwise specified

## Current Limiting Resistor Calculations

$$R_1 \text{ (Non-Invert)} = \frac{V_{DD1} - V_{DF} - V_{OL1}}{I_F}$$

$$R_1 \text{ (Invert)} = \frac{V_{DD1} - V_{OH1} - V_{DF}}{I_F}$$

$$R_2 = \frac{V_{DD2} - V_{OLX} (@ I_L - I_2)}{I_L}$$

### Where:

$V_{DD1}$  = Input Supply Voltage

$V_{DD2}$  = Output Supply Voltage

$V_{DF}$  = Diode Forward Voltage

$V_{OL1}$  = Logic "0" Voltage of Driver

$V_{OH1}$  = Logic "1" Voltage of Driver

$I_F$  = Diode Forward Current

$V_{OLX}$  = Saturation Voltage of Output Transistor

$I_L$  = Load Current Through Resistor  $R_2$

$I_2$  = Input Current of Output Gate

| INPUT      |          | R1 (V) | OUTPUT    |            |        |        |        |        |        |
|------------|----------|--------|-----------|------------|--------|--------|--------|--------|--------|
|            |          |        | CMOS @ 5V | CMOS @ 10V | 74XX   | 74LXX  | 74SXX  | 74LSXX | 74HXX  |
|            |          |        | R2 (V)    | R2 (V)     | R2 (V) | R2 (V) | R2 (V) | R2 (V) | R2 (V) |
| CMOS @ 5V  | NON-INV. | 2000   | 1000      | 2200       | 750    | 1000   | 1000   | 1000   | 560    |
|            | INV.     | 510    |           |            |        |        |        |        |        |
| CMOS @ 10V | NON-INV. | 5100   |           |            |        |        |        |        |        |
|            | INV.     | 4700   |           |            |        |        |        |        |        |
| 74XX       | NON-INV. | 2200   |           |            |        |        |        |        |        |
|            | INV.     | 180    |           |            |        |        |        |        |        |
| 74LXX      | NON-INV. | 1800   |           |            |        |        |        |        |        |
|            | INV.     | 100    |           |            |        |        |        |        |        |
| 74SXX      | NON-INV. | 2000   |           |            |        |        |        |        |        |
|            | INV.     | 360    |           |            |        |        |        |        |        |
| 74LSXX     | NON-INV. | 2000   |           |            |        |        |        |        |        |
|            | INV.     | 180    |           |            |        |        |        |        |        |
| 74HXX      | NON-INV. | 2000   |           |            |        |        |        |        |        |
|            | INV.     | 180    |           |            |        |        |        |        |        |

Fig. 1 Resistor Values for Logic Interface



Fig. 2 Non-Inverting Logic Interface



Fig. 3 Inverting Logic Interface

## Typical Performance Curves

Fig. 4 LED Forward Current vs. Forward Voltage

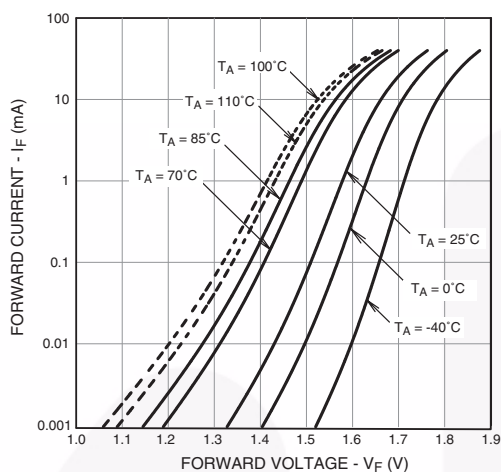


Fig. 5 LED Forward Voltage vs. Temperature

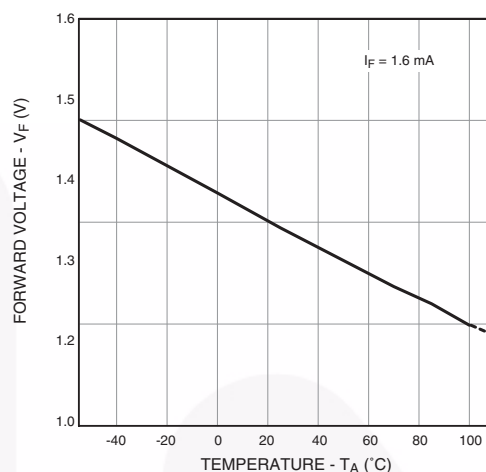


Fig. 6 Current Transfer Ratio vs. Forward Current (6N138M / 6N139M Only)

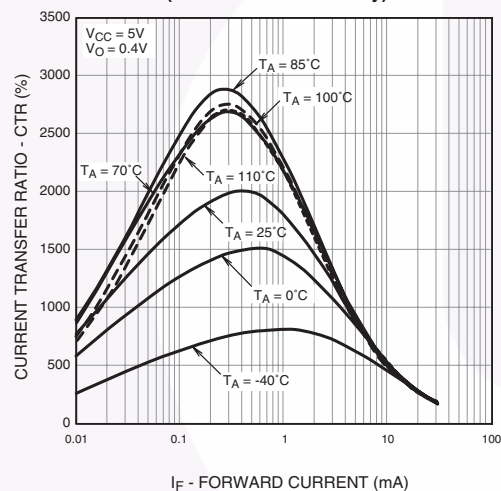


Fig. 7 Normalized Current Transfer Ratio vs. Ambient Temperature (6N138M / 6N139M Only)

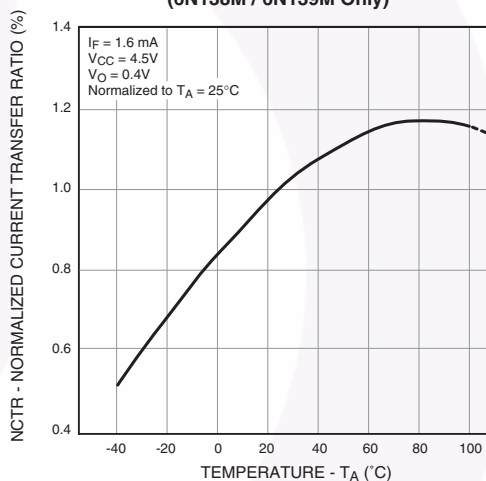


Fig. 8 Current Transfer Ratio vs. Base-Emitter Resistance (6N138M / 6N139M Only)

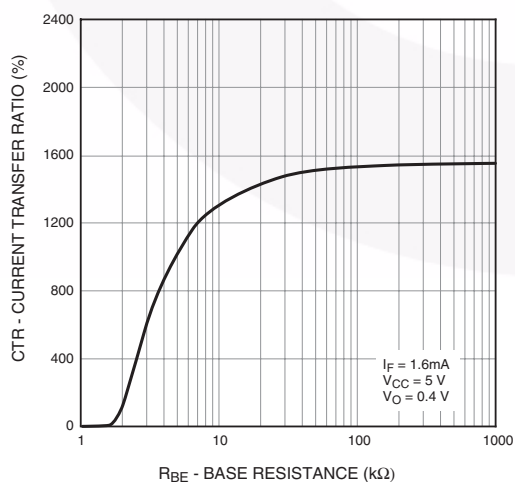
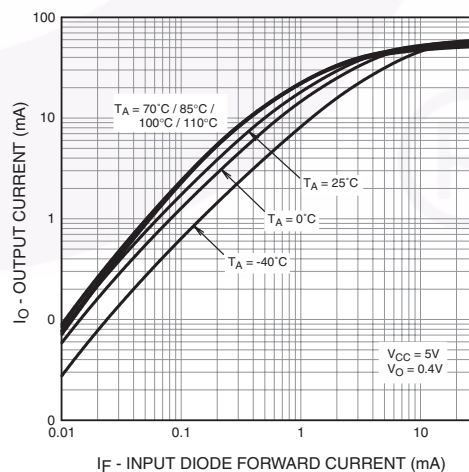
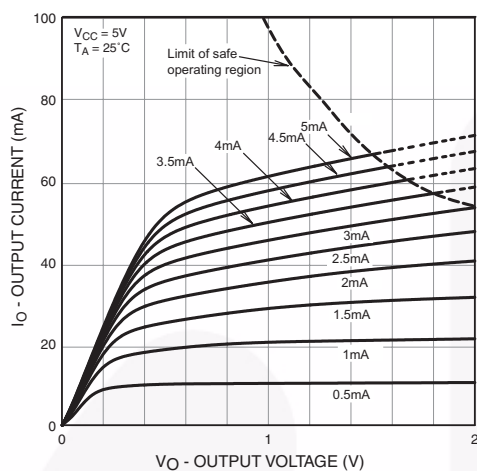


Fig. 9 Output Current vs. Input Diode Forward Current (6N138M / 6N139M Only)

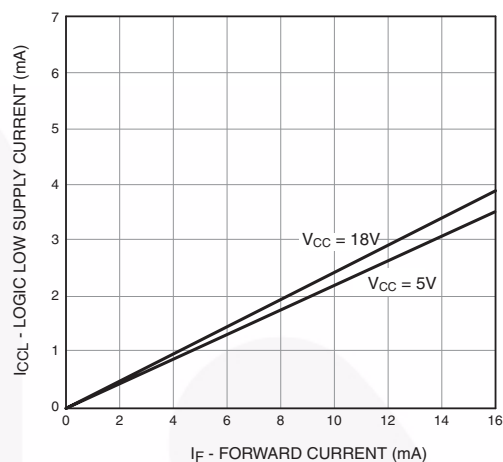


## Typical Performance Curves (Continued)

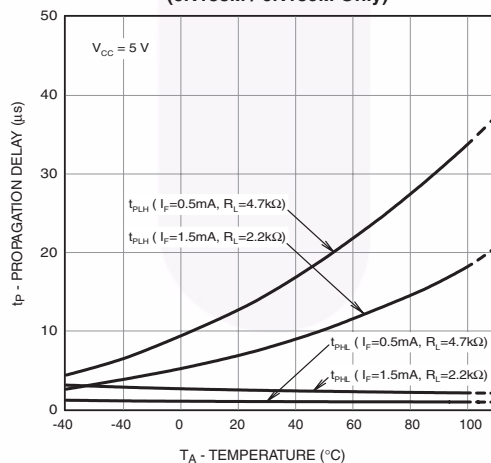
**Fig. 10 Output Current vs Output Voltage**  
(6N138M / 6N139M Only)



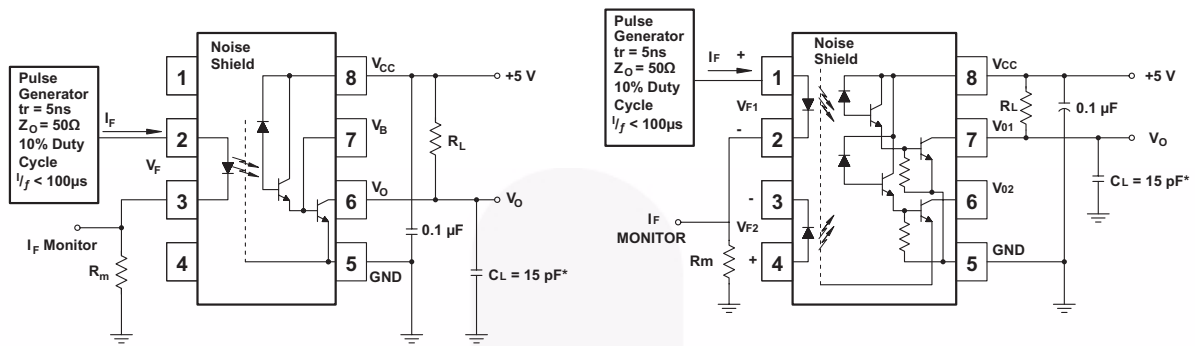
**Fig. 11 Logic Low Supply Current vs. Input Diode Forward Current**  
(6N138M / 6N139M Only)



**Fig. 12 Propagation Delay vs. Temperature**  
(6N138M / 6N139M Only)



## Test Circuits



Test Circuit for 6N138M, 6N139M

Test Circuit for HCPL2730M and HCPL2731M

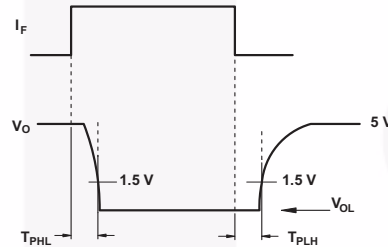
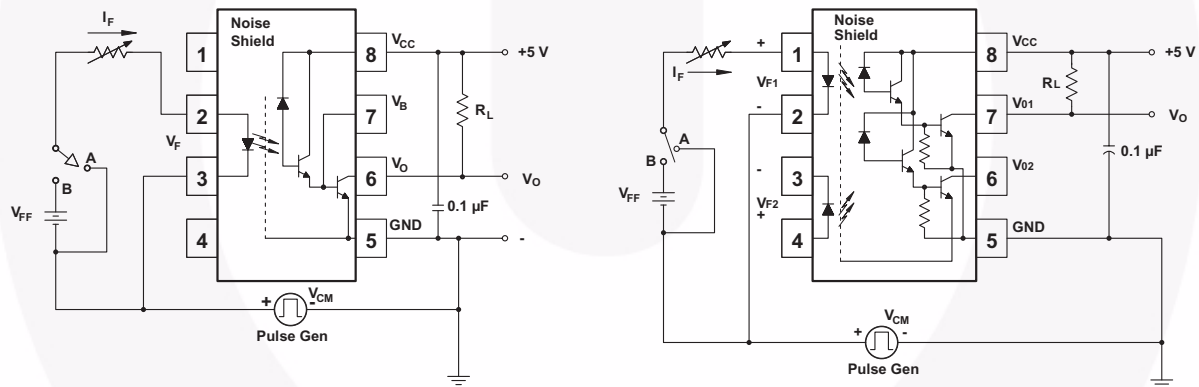


Fig. 13 Switching Time Test Circuit



Test Circuit for 6N138M and 6N139M

Test Circuit for HCPL2730M and HCPL2731M

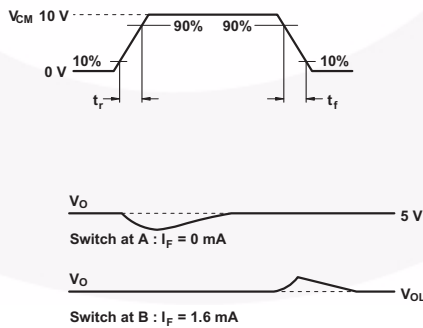
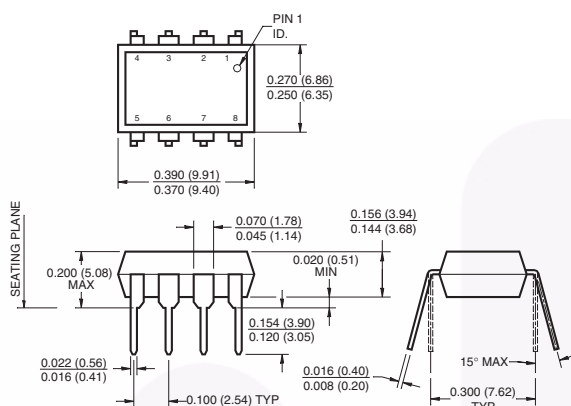


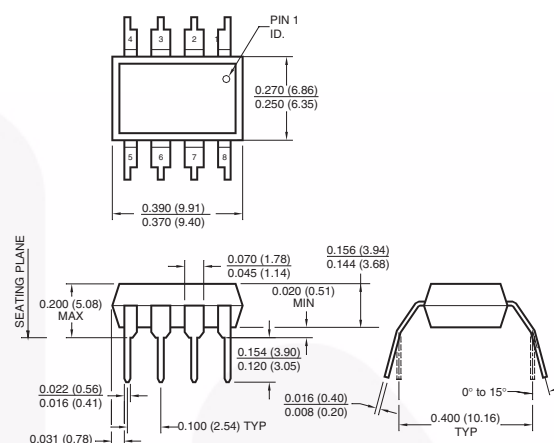
Fig. 14 Common Mode Immunity Test Circuit

## Package Dimensions

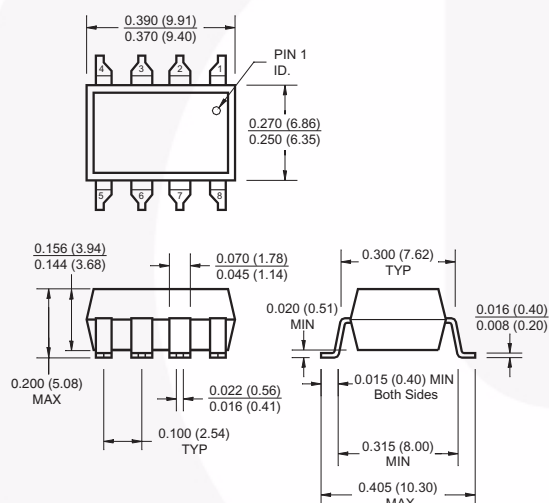
### Through Hole



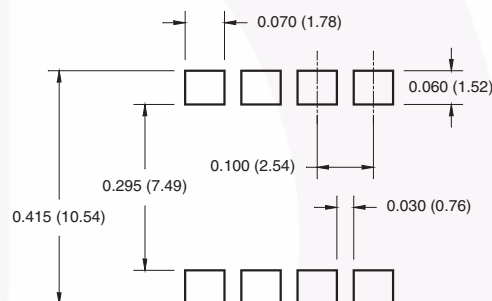
### 0.4" Lead Spacing (Option TV) (Pending)



### Surface Mount – 0.3" Lead Spacing (Option S)



### 8-Pin Surface Mount DIP – Land Pattern (Option S)



#### Note:

All dimensions are in inches (millimeters)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

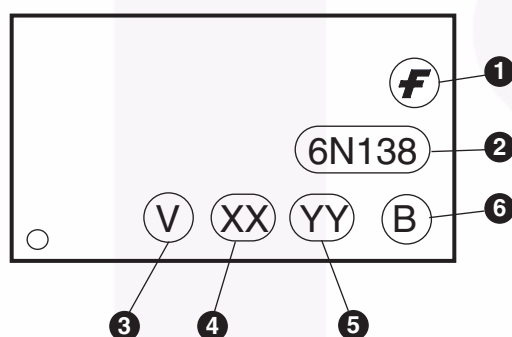
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

## Ordering Information

| Option    | Example Part Number | Description                                                       |
|-----------|---------------------|-------------------------------------------------------------------|
| No Suffix | 6N138M              | Standard Through Hole Device, 50 pcs per tube                     |
| S         | 6N138SM             | Surface Mount Lead Bend                                           |
| SD        | 6N138SDM            | Surface Mount; Tape and reel                                      |
| V         | 6N138VM             | IEC60747-5-2 approval pending (VDE)                               |
| TV        | 6N138TVM            | IEC60747-5-2 approval pending (VDE); 0.4" lead spacing            |
| SV        | 6N138SVM            | IEC60747-5-2 approval pending (VDE); surface mount                |
| SDV       | 6N138SDVM           | IEC60747-5-2 approval pending (VDE); surface mount; tape and reel |

## Marking Information



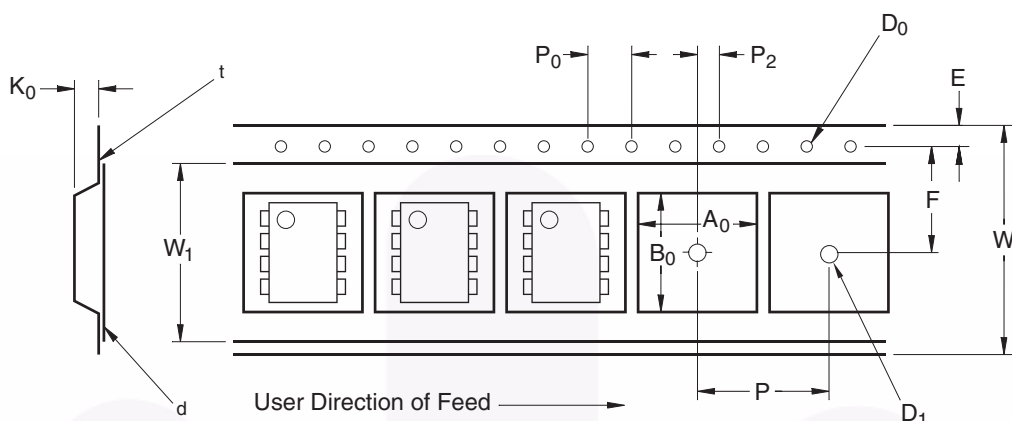
| Definitions |                                                                                                           |
|-------------|-----------------------------------------------------------------------------------------------------------|
| 1           | Fairchild logo                                                                                            |
| 2           | Device number                                                                                             |
| 3           | VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table) (pending approval) |
| 4           | Two digit year code, e.g., '07'                                                                           |
| 5           | Two digit work week ranging from '01' to '53'                                                             |
| 6           | Assembly package code                                                                                     |

### Note:

'HCPL' devices are marked only with the numerical characters (for example, HCPL2730 is marked as '2730').

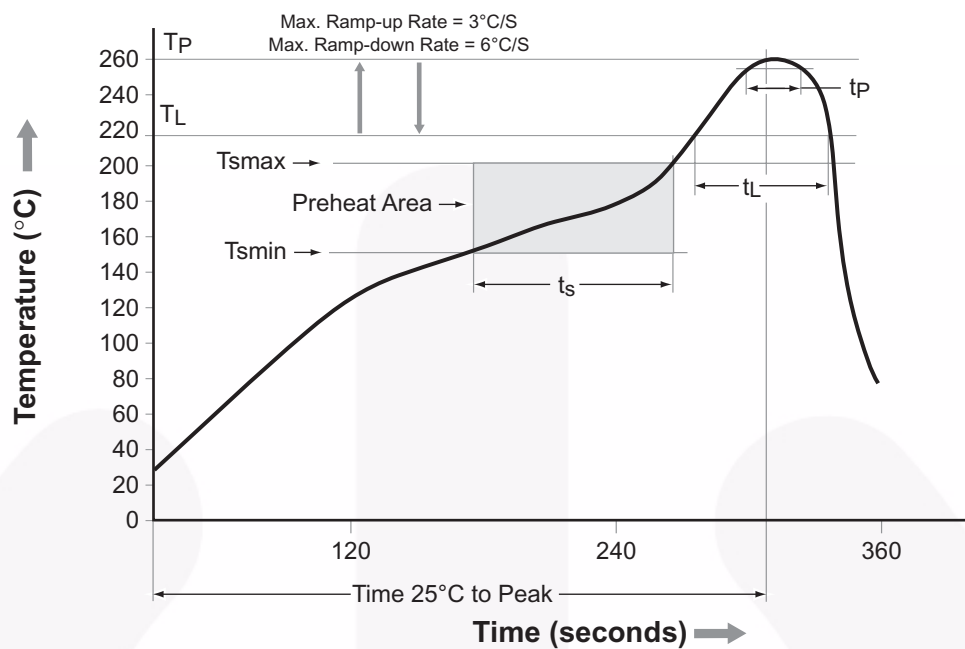
The 'M' suffix on the part number is an order identifier only. It is used to identify orders for the white package version. The 'M' does not appear on the device's top mark.

# Carrier Tape Specifications (Option SD)



| Symbol         | Description                     | Dimension in mm |
|----------------|---------------------------------|-----------------|
| W              | Tape Width                      | 16.0 ± 0.3      |
| t              | Tape Thickness                  | 0.30 ± 0.05     |
| P <sub>0</sub> | Sprocket Hole Pitch             | 4.0 ± 0.1       |
| D <sub>0</sub> | Sprocket Hole Diameter          | 1.55 ± 0.05     |
| E              | Sprocket Hole Location          | 1.75 ± 0.10     |
| F              | Pocket Location                 | 7.5 ± 0.1       |
| P <sub>2</sub> |                                 | 2.0 ± 0.1       |
| P              | Pocket Pitch                    | 12.0 ± 0.1      |
| A <sub>0</sub> | Pocket Dimensions               | 10.30 ± 0.20    |
| B <sub>0</sub> |                                 | 10.30 ± 0.20    |
| K <sub>0</sub> |                                 | 4.90 ± 0.20     |
| W <sub>1</sub> | Cover Tape Width                | 13.2 ± 0.2      |
| d              | Cover Tape Thickness            | 0.1 max         |
|                | Max. Component Rotation or Tilt | 10°             |
| R              | Min. Bending Radius             | 30              |

## Reflow Profile



| Profile Feature                                                       | Pb-Free Assembly Profile |
|-----------------------------------------------------------------------|--------------------------|
| Temperature Min. (T <sub>smin</sub> )                                 | 150°C                    |
| Temperature Max. (T <sub>smax</sub> )                                 | 200°C                    |
| Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> ) | 60–120 seconds           |
| Ramp-up Rate (t <sub>L</sub> to t <sub>p</sub> )                      | 3°C/second max.          |
| Liquidous Temperature (T <sub>L</sub> )                               | 217°C                    |
| Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )             | 60–150 seconds           |
| Peak Body Package Temperature                                         | 260°C +0°C / –5°C        |
| Time (t <sub>p</sub> ) within 5°C of 260°C                            | 30 seconds               |
| Ramp-down Rate (T <sub>p</sub> to T <sub>L</sub> )                    | 6°C/second max.          |
| Time 25°C to Peak Temperature                                         | 8 minutes max.           |



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|--------------------------|-----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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